

Vishay Siliconix

Dual P-Channel 1.8-V (G-S) MOSFET

CHARACTERISTICS

- P-Channel Vertical DMOS
- Macro Model (Subcircuit Model)
- · Level 3 MOS

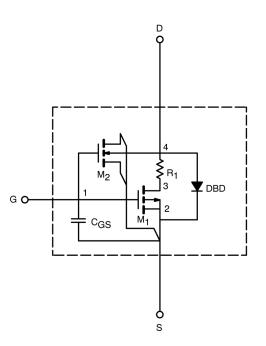
- · Apply for both Linear and Switching Application
- Accurate over the -55 to 125°C Temperature Range
- Model the Gate Charge, Transient, and Diode Reverse Recovery Characteristics

DESCRIPTION

The attached spice model describes the typical electrical characteristics of the p-channel vertical DMOS. The subcircuit mode is extracted and optimized over the -55 to 125° C temperature ranges under the pulsed 0-to-5V gate drive. The saturated output impedance is best fit at the gate bias near the threshold voltage.

SUBCIRCUIT MODEL SCHEMATIC

A novel gate-to-drain feedback capacitance network is used to model the gate charge characteristics while avoiding convergence difficulties of the switched C_{qd} model. All model parameter values are optimized to provide a best fit to the measured electrical data and are not intended as an exact physical interpretation of the device.



This document is intended as a SPICE modeling guideline and does not constitute a commercial product data sheet. Designers should refer to the appropriate data sheet of the same number for guaranteed specification limits.

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SPECIFICATIONS (T _J = 25°C UN	LESS OTHERW	ISE NOTED)			
Parameter	Symbol	Test Condition	Simulated Data	Measured Data	Unit
Static					
Gate Threshold Voltage	V _{GS(th)}	V_{DS} = V_{GS} , I_D = -250μ A	0.81		V
On-State Drain Current ^a	I _{D(on)}	$V_{DS} < -5V, V_{GS} = -4.5V$	43		А
Drain-Source On-State Resistance ^a	r _{DS(on)}	$V_{GS} = -4.5V, I_D = -3.4A$	0.053	0.058	Ω
		$V_{GS} = -2.5V, I_D = -2.7A$	0.085	0.090	
		$V_{GS} = -1.8V, I_D = -1A$	0.129	0.131	
Forward Transconductance ^a	g _{fs}	$V_{DS} = -5V, I_D = -3.4A$	8.3	8	S
Diode Forward Voltage ^a	V _{SD}	$I_{\rm S}$ = -0.90 A, $V_{\rm GS}$ = 0V	- 0.80	- 0.80	V
Dynamic ^b					
Total Gate Charge	Qg	V_{DS} = - 4V, V_{GS} = - 4.5V, I_D = - 3.4A	5.9	5.9	nC
Gate-Source Charge	Q _{gs}		1.3	1.3	
Gate-Drain Charge	Q _{gd}		1.4	1.4	
Turn-On Delay Time	t _{d(on)}	$\label{eq:V_DD} \begin{array}{l} V_{\text{DD}} = - 4 V, \ R_{\text{L}} = 4 \Omega \\ I_{\text{D}} \cong - 1 A, \ V_{\text{GEN}} = - 4.5 V, \ R_{\text{G}} = 6 \Omega \end{array}$	38	20	• ns
Rise Time	tr		68	70	
Turn-Off Delay Time	$t_{d(off)}$		26	35	
Fall Time	t _f		35	35	
Source-Drain Reverse Recovery Time	t _{rr}	$I_F = -0.90A$, di/dt = 100A/ μ s	33	30	

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2%. b. Guaranteed by design, not subject to production testing.

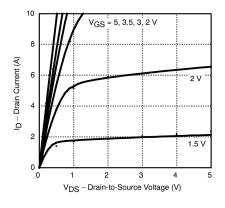
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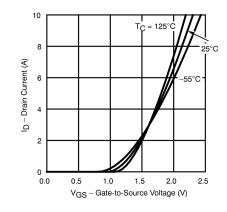


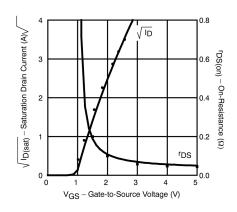
SPICE Device Model Si5915DC

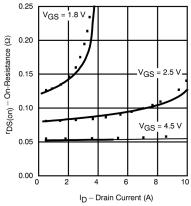
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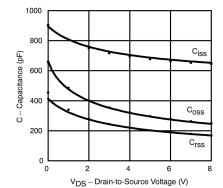
COMPARISON OF MODEL WITH MEASURED DATA (TJ=25°CUNLESS OTHERWISE NOTED)



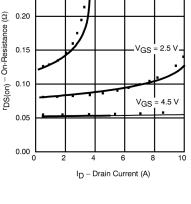


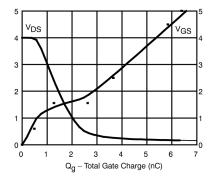






Note: Dots and squares represent measured data.





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Datasheets for electronics components.